

Inspection system Application: After stencil printing, pre/post reflow oven, pre/post wave soldering, FPC etc.

Inspection Items:

- 1) **Stencil printing:** Solder unavailability, insufficient or excessive solder, solder misalignment, bridging, stain, scratch etc.
- 2) **Component defect:** missing or excessive component, misalignment, uneven, edging, opposite mounting, wrong or bad component etc.
- 3) **DIP:** Missing parts, damage parts, offset, skew, inversion, etc
- 4) **Soldering defect:** excessive or missing solder, empty soldering, bridging, solder ball, IC NG, copper stain etc.
- 5) Calculation Method: Machine learning, color calculation, color extraction, gray scale operation, image contrast.
- 6) Inspection mode: PCB fully covered, with array and bad marking function.
- 7) **SPC statistics function:** Fully record the test data and make analysis, with high flexibility to check production and quality status.
- 8) Optical system:

Camera: 5 million pix full color high speed industrial digital camera ,20 million pix camera optional.

Lens resolution: 10um/15um/18um/20um/25um, can be custom-made.

> Lighting source Annular stereo multi-channel color light, RGB/RGBW/RGBR/RWBR optional.

9) Minimum component: 0201 chip, 0.3 pitch IC.

NeoDen ND800 online AOI machine SPC statistics function: Fully record the test data and make analysis, with high flexibility to check production and quality status.

| Technical Specifications: | |
|-------------------------------------|-----------------------------------|
| Model | Nd800 |
| PCB Thickness | 0.3mm~5mm |
| Max. PCB Size (X x Y) | 400mm x 360mm |
| Min. PCB Size (Y x X) | 50mm x 50mm |
| Max. Bottom Gap | 75mm |
| Max. Top Gap | 35mm |
| Moving speed | 830mm/Sec(Max) |
| Transmission height from the ground | 900±20mm |
| Air pressure | 0.4 – 0.8MPa |
| PCB bending | <5mm or 3% of PCB Diagonal length |
| Power | AC220V, 50/60Hz, 1.5KW |
| Machine dimension | 980mm * 980mm * 1620mm |
| Weight | 550KG |